L Number	Hits	Search Text	DB	Time stamp
3	6	(("20040067653") or ("20030082900") or	USPAT;	2004/09/03 12:12
		("6548394") or ("6492211") or ("6190974") or ("5795802")).PN.	US-PGPUB	
4	7	(implant\$8 same (ILD near3 mask) same	USPAT;	2004/09/03 12:13
		gate)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	210	(420/142) CCT C	IBM_TDB USPAT;	2004/08/31 08:23
-	210	(438/142).CCLS.	US-PGPUB;	2004/00/31 00:23
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1303	(438/217).CCLS.	USPAT;	2004/08/31 08:23
			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
_	623	(438/199).CCLS.	USPAT;	2004/08/31 08:23
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
]_	300	(438/233).CCLS.	IBM_TDB USPAT;	2004/08/31 08:23
_	300	(438/233).CCLS.	US-PGPUB;	2004/08/31 08:23
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	504	(438/231).CCLS.	USPAT;	2004/08/31 08:24
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	311	(438/232).CCLS.	USPAT;	2004/08/31 08:24
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	1137	(438/301).CCLS.	<pre>IBM_TDB USPAT;</pre>	2004/08/31 08:24
	110,	(100,001,10020.	US-PGPUB;	2001, 00, 01 00.21
			EPO; JPO;	
			DERWENT;	
	2050	(430/305) CCIS	<pre>IBM_TDB USPAT;</pre>	2004/09/01 07:41
-	2050	(438/305).CCLS.	USPAT; US-PGPUB;	2004/09/01 07:41
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	460	(438/306).CCLS.	USPAT;	2004/08/31 08:24
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	687	(438/527).CCLS.	USPAT;	2004/08/31 08:24
			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
_	219	(438/533).CCLS.	USPAT;	2004/08/31 08:24
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
i _	2162	(438/586).CCLS.	IBM_TDB USPAT;	2004/08/31 08:24
-	2102	(450/500/.0015.	US-PGPUB;	2004/00/31 00:24
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	496	(438/682).CCLS.	USPAT;	2004/08/31 08:25
	150	(130,002,1002)	US-PGPUB;	2001,00,01
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	440	(438/664).CCLS.	USPAT;	2004/08/31 08:25
_	1 440	(430,004).0043.	US-PGPUB;	2004/00/31 00.23
			EPO; JPO;	
			DERWENT;	
		4420 (640) 0070	IBM_TDB	0004/00/21 00:05
-	444	(438/649).CCLS.	USPAT;	2004/08/31 08:25
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1644	(438/655).CCLS.	USPAT;	2004/08/31 08:25
			US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	
_	2665	438/142,217,199,233,231,232,301,305,306,527	, 5056 Ā 5 133, 682	,8094689/68412c12.
		and gate and source and drain and silicide	US-PGPUB;	
	1	and (plug or contact) and @ad<=20031229	EPO; JPO;	
	'		DERWENT;	
		,	IBM TDB	
_	1841	438/\$.ccls. and gate and source and drain	USPAT;	2004/08/31 08:39
		and (light\$3 adj (dop\$5 or implant\$6)) and	US-PGPUB;	
		((heav\$4 or deep\$3 or depth) adj (dop\$5 or	EPO; JPO;	
		implant\$6)) and silicide and (plug or	DERWENT;	
		contact) and @ad<=20031229	IBM TDB	
_	3012	semiconductor and gate and source and	USPAT;	2004/08/31 08:39
	3012	drain and (light\$3 adj (dop\$5 or	US-PGPUB;	2004/00/31 00.33
		implant\$6)) and ((heav\$4 or deep\$3 or	EPO; JPO;	
		depth) adj (dop\$5 or implant\$6)) and	DERWENT;	
		silicide and (plug or contact) and	IBM TDB	
		@ad<=20031229	1011_100	
_	2692		USPAT;	2004/08/31 08:39
	2032		· · · · · · · · · · · · · · · · · · ·	2004/00/31 00.39
		and (light\$3 adj (dop\$5 or implant\$6)) and	US-PGPUB;	
		((heav\$4 or deep\$3 or depth) adj (dop\$5 or	EPO; JPO;	
		implant\$6)) and silicide and (plug or	DERWENT;	
_	686	contact) and @ad<=20031229 438/142,217,199,233,231,232,301,305,306,527	IBM_TDB	50014BB/55108-31
-	000		US-PGPUB;	,8094688/85408c13.
		and gate and source and drain and (light\$3		
		adj (dop\$5 or implant\$6)) and ((heav\$4 or	EPO; JPO;	
		deep\$3 or depth) adj (dop\$5 or implant\$6))	DERWENT;	
		and silicide and (plug or contact) and	IBM_TDB	2004/00/01 27 11
_	8	@#d\$\#27008\\\2279\\5194926\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	USPAT	2004/09/01 07:41
		"5739573" "5747373" "5763312"		
	1	"5770508" "5780348").PN.		0004/00/01 10 1-
_	10		USPAT	2004/08/31 12:33
		"5316964" "5444024" "5550084"		
	1	"5589423" "5773339" "5838033"		
		"5883010").PN.		
_	2	("6667233").PN.	USPAT;	2004/09/03 12:09
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	1		IBM TDB	